

# TRANSMITTAL FORM

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Attorney Docket Number: XDEV1100



## CONTACT METHOD FOR THIN SILICON CARBIDE EPITAXIAL LAYER AND SEMICONDUCTOR DEVICES FORMED BY THOSE METHODS

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SUBMITTED BY

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Date Signed: 20010727

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Attached Files:

specification	Xdev1100.xml
declaration	Dec1.tif
declaration	Dec2.tif
declaration	Dec3.tif

fee-transmittal  
bibd-transmittal  
patent-assignment

XDEV1100fee.xml  
XDEV1100apds.xml  
XDEV1100asgn.xml

Attached Image File(s):

Dec1.tif  
Dec2.tif  
Dec3.tif

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Comments:

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# FEE TRANSMITTAL

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Small Entity

**TOTAL FEES AUTHORIZED: \$ 395**

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SUBMITTED BY

Authorized Name: George R. Meyer

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Date Signed: 20010727

BASIC FILING FEE

Fee Description	Fee Code	Fee Paid
Utility Filing Fee	201	\$ 355

Subtotal For Basic Filing Fee: \$ 355

EXTRA CLAIM FEES

	Fee Code	Fee	Extra Claims	Fee Paid
Total Claims: 15	203	\$ 9	0	\$ 0
Independent Claims: 2	202	\$ 40	0	\$ 0

Subtotal For Extra Claims Fees: \$ 0

ADDITIONAL FEES

Fee Description	Fee Code	Fee Paid
Recording Each Patent Assignment Per Property Fee	581	\$ 40

Subtotal For Additional Fees: \$ 40

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**Electronic Filing System (EFS) Data**  
**Electronic Patent Application Submission**  
**USPTO Use Only**

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Application ID: 09682151  
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First Named Inventor: Martin Kordesch  
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